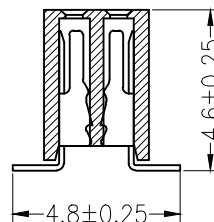
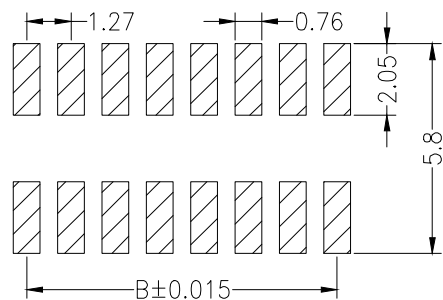


PIN 0.5x0.15



Recommended P.C.B Layout(Top Side)
(PCB BOARD TOLERANCE±0.05)



Ordering Information

23 43U-2 XX X N XX M N T 01

Plastic high
43=H4.3mm

No. of Pins
Per Row
01~50P

Insulator Material
Option
A=PBT
B=PA66
C=PA6T
D=PA46
E=PA9T
F=LCP

Contact Plating
G1:1U" Gold
G2:1.5U" Gold
G3:2U" Gold
G4:3U" Gold
G5:5U" Gold
G6:10U" Gold
G7:15U" Gold
S0:Gold Flash/Tin
SN:Tin

Packing
0=PE Bag
A=Tray
T=Tube
P=Tube+Cap
R=Reel+Cap
M=Reel+Mylar

code stream
01~99

SPECIFICATIONS

Rated Current:1.0AMP

Contact Resistance:20mΩ Max

Withstand Voltage:500V AC/DC

Insulation Resistance:1000MΩ Min

Operation Temperature:-40°c to +105°c

Contact Material:Phosphor Brass

Contact Plating:Au or Sn Over Ni

Insulator Material:Polyester(UL94V-0)

Standard: PA6T

Max.Processing Temp: 230°C for 30-60 seconds
(260°C for 10 seconds)

Dimen Sions List

Contacts Per row	Dimensions		Contacts Per row	Dimensions	
	A	B		A	B
			26	33.42	31.75
2	2.94	1.27	27	34.69	33.02
3	4.21	2.54	28	35.96	34.29
4	5.48	3.81	29	37.23	35.56
5	6.75	5.08	30	38.50	36.83
6	8.02	6.35	31	39.77	38.10
7	9.29	7.62	32	41.04	39.37
8	10.56	8.89	33	42.31	40.64
9	11.93	10.16	34	43.58	41.91
10	13.10	11.43	35	44.85	43.18
11	14.37	12.70	36	46.12	44.45
12	15.64	13.97	37	47.39	45.72
13	16.91	15.24	38	48.66	46.99
14	18.18	16.51	39	49.93	48.26
15	19.45	17.78	40	51.20	49.53
16	20.72	19.05	41	52.47	50.80
17	21.99	20.32	42	53.74	52.07
18	23.26	21.59	43	55.01	53.34
19	24.53	22.86	44	56.28	54.61
20	25.90	24.13	45	57.55	55.88
21	27.07	25.40	46	58.82	57.15
22	28.34	26.67	47	60.09	58.42
23	29.61	27.94	48	61.36	59.69
24	30.88	29.21	49	62.63	60.96
25	32.15	30.48	50	63.90	62.23



深圳市华宇创精密电子有限公司

TOLERANCE:

X.X ±0.30

X.XX ±0.25

X.XXX ±0.15

X." ±2" X.X" ±0.5"

UNIT: mm [inch]

SCALE:1:1

SIZE: A4

DRAWN BY :

陈一鸣

DATE :

2014-02-23

PART NAME:

1.27X4.3FH 2XNP SMT

CHECKED BY:

马跃

DATE :

2014-02-23

PART NO.

2343U-2XXXNXXMNT01

MOLD NO.

APPROVED BY:

DATE :

2014-02-23

DRAW NO:

HYC-1812011011

SHEET NO.

1 OF 1